# **Hardware**

## **Documentation**

Version 1.00 PRELIMINARY (2012-06-29)



PicoMOD7A TTL

## **About This Document**

This document describes the hardware of the PicoMOD7A-digital for TTL display interface. For the LVDS display interface version of this product there is a separate document. The latest version of this document can be found at <a href="http://www.fs-net.de">http://www.fs-net.de</a>.

## **History**

Date	٧	Platform	A,M,R	Chapter	Description	Au
2012-06-29	1.00	PicoMOD7A	Α	-	Hardware documentation, preliminary	DB

V Version

A,M,R Added, Modified, Removed

Au Author



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## 1 Technical Data Connectors

The PicoMOD7A is equipped with a TycoElectronics 5177984-6 (140 pin, 0.8mm) connector from '0.8mm Free Height (FH) Connectors' series. For position and orientation please look chapter 4 "DimensionsA"

#### Matching connectors are:

5mm stacking height: TycoElectronics 5177983-6
9mm stacking height: TycoElectronics 5-5179009-6
13mm stacking height: TycoElectronics 5-5179010-6



## 2 Connectors

## 2.1 Counting of the connector pins

The connector plug of PicoMOD7A TTL will be treated as follows. Pin 1 is marked in Figure 1. The row with pin 1 contains all odd-numbered pins (1, 3, 5, 7 etc.), and corresponding to this, the row without pin 1 contains all even-numbered pins (2, 4, 6, 8 etc.).

#### 2.2 IO-Pin limitations

PicoMOD7A TTL is equipped with 67 pins that can be used as digital-IO. Most of these pins are multiplexed, so you have to make sure that these pins are used for one purpose only. For example, if you intend to use IO0 to IO3 you have to make sure that the COM2 is disabled. Additionally there are some IO-Pins which are used internally and whose primary function can't be disabled completely.

## 2.3 Connector J1 (main connector)

	J1					
Pin	Signal	Default Interface	Alternative Function			
1	IO64	I/O-Pin 64	SPI CS			
2	IO65	I/O-Pin 65	SPI CLK			
3	IO66	I/O-Pin 66	SPI MISO			
4	IO67	I/O-Pin 67	SPI MOSI			
5	CAN-TX	CAN2.0 TX				
6	CAN-RX	CAN2.0 RX				
7	RX-	Ethernet RX-				
8	TX-	Ethernet TX-				
9	RX+	Ethernet RX+				
10	TX+	Ethernet TX+				
11	V33	+3,3V ±5% DC				
12	V33	+3,3V ±5% DC				
13	GND	GND				
14	GND	GND				
15	/PONRES	CPU Reset (active low)				
16	VBAT	+3V +3,6V DC				
		(Battery buffering RTC) (*)				



J1					
Pin	Signal	Default Interface	Alternative Function		
17	IO1	COM2 TxD	I/O-Pin 1		
18	IO0	COM2 RxD	I/O-Pin 0		
19	IO3	COM2 RTS	I/O-Pin 3 / COM4 TX		
20	IO2	COM2 CTS	I/O-Pin 2 / COM4 RX		
21	IO5	COM1 TxD	I/O-Pin 5		
22	IO4	COM1 RxD	I/O-Pin 4		
23	IO7	I/O-Pin 7	COM3 TxD		
24	IO6	I/O-Pin 6	COM3 RxD		
25	OTGDM	USB2.0 OTG Dev./Host -			
26	USBDN	USB2.0 Host -			
27	OTGDP	USB2.0 OTG Dev./Host +			
28	USBDP	USB2.0 Host +			
29	IO9	I/O-Pin 9 / GPIO5			
30	IO8	I/O-Pin 8	USB Host Power On		
31	IO11	I/O-Pin 11	I2C SDA		
32	IO10	I/O-Pin 10	USB Device Detect		
33	IO76	I/O-Pin 76			
34	IO12	I/O-Pin 12	I2C SCL		
35	BOOTSEL0	NC (do not use)			
36	IO77	I/O-Pin 77			
37	BOOTSEL1	NC (do not use)			
38	BOOTSEL2	NC (do not use)			
39	GND	GND			
40	GND	GND			
41	IO14	I/O-Pin 14 / GPIO1			
42	IO13	I/O-Pin 13 / GPIO0			
43	IO16	I/O-Pin 16 / GPIO3			
44	IO15	I/O-Pin 15 / GPIO2			
45	IO18	I/O-Pin 18	SD-Card CLK		
46	IO17	I/O-Pin 17 / GPIO4			
47	IO20	I/O-Pin 20	SD-Card DAT0		
48	IO19	I/O-Pin 19	SD-Card CMD		
49	IO22	I/O-Pin 22	SD-Card DAT2		



	J1					
Pin	Signal	Default Interface	Alternative Function			
50	IO21	I/O-Pin 21	SD-Card DAT1			
51	IO24	I/O-Pin 24	SD-Card Detect			
52	IO23	I/O-Pin 23	SD-Card DAT3			
53	IO26	I/O-Pin 26	SD-Card Write Protect			
54	IO25	I/O-Pin 25	SD-Card Power Enable			
55	IO28	I/O-Pin 28	LCD DEN (Display enable)			
56	1027	I/O-Pin 27	LCD Enable			
57	IO30	I/O-Pin 30	LCD VCFL On			
58	IO29	I/O-Pin 29	LCD VLCD On			
59	GND	GND				
60	IO31	I/O-Pin 31	LCD VEEK			
61	VIO0	I/O-Pin 32	LCD VD0			
62	GND	GND				
63	VIO2	I/O-Pin 34	LCD VD2			
64	VIO1	I/O-Pin 33	LCD VD1			
65	VIO4	I/O-Pin 36	LCD VD4			
66	VIO3	I/O-Pin 35	LCD VD3			
67	VIO6	I/O-Pin 38	LCD VD6			
68	VIO5	I/O-Pin 37	LCD VD5			
69	VIO8	I/O-Pin 40	LCD VD12			
70	VIO7	I/O-Pin 39	LCD VD7			
71	VIO10	I/O-Pin 42	LCD VD14			
72	VIO9	I/O-Pin 41	LCD VD13			
73	VIO12	I/O-Pin 44	LCD VD18			
74	VIO11	I/O-Pin 43	LCD VD15			
75	VIO14	I/O-Pin 46	LCD VD20			
76	VIO13	I/O-Pin 45	LCD VD19			
77	VIO16	I/O-Pin 48	LCD VD22			
78	VIO15	I/O-Pin 47	LCD VD21			
79	VIO18	I/O-Pin 50	LCD VLINE			
80	VIO17	I/O-Pin 49	LCD VD23			
81	VIO20	I/O-Pin 52	LCD VM			
82	VIO19	I/O-Pin 51	LCD VFRAME			



J1						
Pin	Signal	Default Interface	Alternative Function			
83	GND	GND				
84	GND	GND				
85	GND	GND				
86	VIO21	I/O-Pin 53	LCD VCLK			
87	IO70	I/O-Pin 70				
88	IO71	I/O-Pin 71				
89	/WAIT	Bus Wait (active low)				
90	1072	I/O-Pin 72				
91	CS4	Chip Select 2				
92	CS5	Chip Select 3				
93	IO73	I/O-Pin 73				
94	IOxx	I/O-Pin				
95	IOxx	I/O-Pin				
96	/OE	Output Enable				
97	/WE	Write Enable				
98	IO74	I/O-Pin 74				
99	A0	Address 0				
100	A1	Address 1				
101	A2	Address 2				
102	A3	Address 3				
103	A4	Address 4				
104	A5	Address 5				
105	A6	Address 6				
106	A7	Address 7				
107	A8	Address 8				
108	A9	Address 9				
109	A10	Address 10				
110	D0	Data 0				
111	D1	Data 1				
112	D2	Data 2				
113	D3	Data 3				
114	D4	Data 4				
115	D5	Data 5				



	J1					
Pin	Signal	Default Interface	Alternative Function			
116	D6	Data 6				
117	D7	Data 7				
118	D8	Data 8				
119	D9	Data 9				
120	D10	Data 10				
121	D11	Data 11				
122	D12	Data 12				
123	D13	Data 13				
124	D14	Data 14				
125	D15	Data 15				
126	IO75	I/O-Pin 75				
127	CS0	Chip Select 1				
128	ETH-ACT	Ethernet Activity				
129	STA1	Status 1				
130	STA2	Status 2				
131	LOUT	Audio Left Out				
132	ROUT	Audio Right Out				
133	LIN	Audio Left In				
134	RIN	Audio Right In				
135	MICIN	Microphone In				
136	MICBIAS	Microphone Bias				
137	X+	Touch X+				
138	X-	Touch X-				
139	Y+	Touch Y+				
140	Y-	Touch Y-				

See PicoMOD7A Starterkit documentation for connection examples.

See software documentation for configuration of alternative functions.



## 2.4 microSD connector

The on board microSD connector can be used on same time as the SD interface on J1. There is no sharing with any signal of the connector J1. There is no hotplug detection for this connector, so the software can't detect a card insert after switching on the board.

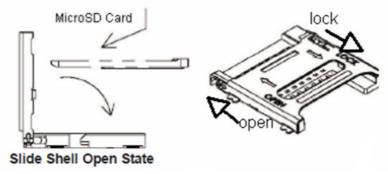


Figure 1: microSD connector



## 3 Interface and Signal description

## 3.1 TFT LCD connection

TFT							
Pin	Signal	12 bit	15 bit	16 bit	18 bit		
61	LCD VD0			G0	G0		
64	LCD VD1	_	G0	G1	G1		
63	LCD VD2	_			B0		
66	LCD VD3	_	B0	B0	B1		
65	LCD VD4	B0	B1	B1	B2		
68	LCD VD5	B1	B2	B2	B3		
67	LCD VD6	B2	B3	B3	B4		
70	LCD VD7	B3	B4	B4	B5		
69	LCD VD12	G0	G1	G2	G2		
72	LCD VD13	G1	G2	G3	G3		
71	LCD VD14	G2	G3	G4	G4		
74	LCD VD15	G3	G4	G5	G5		
73	LCD VD18				R0		
76	LCD VD19	_	R0	R0	R1		
75	LCD VD20	R0	R1	R1	R2		
78	LCD VD21	R1	R2	R2	R3		
77	LCD VD22	R2	R3	R3	R4		
80	LCD VD23	R3	R4	R4	R5		
86	LCD VCLK	DCLK	DCLK	DCLK	DCLK		
79	LCD VLINE	HSYNC	HSYNC	HSYNC	HSYNC		
82	LCD VFRAME	VSYNC	VSYNC	VSYNC	VSYNC		
81	LCD VM	DE	DE	DE	DE		
55	LCD DEN	Display Enab	ole (active high)	l	l		
60	LCD VEEK	PWM Backlig	ght				
57	LCD VCFL On	Power Backl	ight On (active hig	gh)			
58	LCD VLCD On	Power Display On (active high)					

All signals are 3.3V TTL compliant. These signals are not supported on the LVDS version of this product. Please refer the document "PicoMOD7\_LVDS\_Hardware\_eng.pdf".



#### 3.2 Ethernet connection

LAN TX+/- and RX+/- are 100  $\pm 20\%$  Ohm differential pairs to a 1:1/1:1 transformer. We recommend a connector with integrated transformer in short distance (less than 4 inch = 100 mm) to the module connector. The RX pair should have a 0.2 inch min. distance to TX pair to avoid crosstalk. The intra pair mismatch of each differential pair should be <50 mil (1.27mm). Please also refer our "Ethernet Routing Guidelines" on our web download area and refer the comments at our forum.

The LED signals are low active to drive a 3.3V powered LED with 5mA directly. If ethernet is not used please leave signals unconnected.

### 3.3 Serial port

Serial ports are provided with 3.3V TTL signals. These signals are not 5V compliant. Please use a transceiver with 3.3V power supply.

If you don't need the serial port this pins can be used optional as GPIOs.

#### 3.4 USB Host

The 90 Ohm differential pair of USB signals doesn't need any termination. For external ports EMV protection is required nearby the USB connector.

With the USB\_PWR signal you can switch on the USB power on your current limiting IC. From the <u>usb.org</u> webpage you can download "<u>High Speed USB Platform Design Guidelines</u>" which provides highly recommended information for a proper working USB design. If the USB port is not used please leave open.

#### 3.5 USB device

The 90 Ohm differential pair of USB signals doesn't need any termination. For external ports ESD and EMV protection is required nearby the USB connector.

The USB\_CNX signal is for detecting a connection to a host. This signal connects directly to the USB 5V power (4.75 - 5.25V). A buffer can be added to prevent excessive current flow from the USB connector to the board.

From the <u>usb.org</u> webpage you can download "<u>High Speed USB Platform Design Guidelines</u>" which provide highly recommended information for a proper working USB design. If the USB device port is not used please leave open.

#### 3.6 SPI

The module supports a HS SPI (Serial Peripheral Interface) with a chip select. Signals are 3.3V compliant.



#### 3.7 I2C

The module supports an I2C interface. Signals are 3.3V compliant and don't have pull-ups on module. Please add 2.2 kOhm pull-ups to 3.3V on baseboard. 5V devices on baseboard need a level shifter.

I2C for camera and HDMI is soft I2C on GPIO, see starterkit schematics for connection examples.

#### 3.8 CAN

The module provides the CAN TX and CAN RX signals with .3.3V TTL level The RX signal has an internal pull-up and can be left unconnected when not used. A 3.3V transceiver like SN65HVD230 is needed to connect to the CAN bus.

#### 3.9 SD card

The interface is supporting a SD card channel. For specification and licensing please refer the website of the SD Association <a href="http://www.sdcard.org">http://www.sdcard.org</a>. Pull-ups are integrated on the module. Signals are 3.3V compliant.

Unused signals should be left unconnected.

Signals can be optional used as GPIO.

#### **3.10 Touch**

The integrated resistive touch controller will support 4 wire analog resistive touch panels without any additional circuit.

Optional these signals can be used as analog input.

#### 3.11 Audio I/F

The onboard sound codec supports an analog stereo input and an analog stereo output with  $1\ V_{RMS}$  signal level. These signals need serial capacitors.

#### 3.12 IO / IRQ

Multiple general purpose pins with 3.3V logic signal level.

#### **3.13 /PONRES**

Reset input. Drive with open drain or open collector 3.3V compliant signal. We recommend to pull low this pin with the powergood signal from power supply or using a voltage supervisor. For proper function this signal must be connected.



### 3.14 Address/Data-Bus

The PicoMOD7A module does provide an address/data bus to connect ICs for additional functions. Bus supports 3.3V TTL level. This interface can be used to implement a NetDCU compatible FS-Bus (8bit with data/address select)

Adress A10..0
Data D15..0
Chip select /CS0
Output Enable /OE
Write Enable /WE

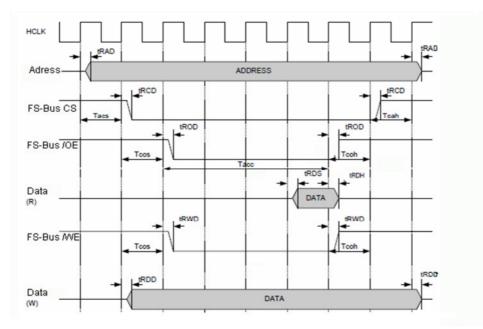


Figure 2: FS-Bus timing

Parameter	Symbol	Min	Max	Unit
ROM/SRAM Address Delay	tRAD	1.2823	7.8220	ns
ROM/SRAM Chip Select Delay	tRCD	1.9564	6.6403	ns
ROM/SRAM nOE(Output Enable) Delay	tROD	1.8143	6.4113	ns
ROM/SRAM nWE(Write Enable) Delay	tRWD	1.7700	6.2336	ns
ROM/SRAM Output Data Delay	tRDD	1.1940	8.2706	ns
ROM/SRAM Read Data Setup Time	trds	2.0000	-	ns
ROM/SRAM Write Data Hold Time	trdh	1.0000	-	ns



## 4 Dimensions

Board thickness: 1.6 mm Height of parts on top side: 3.0 mm

Height of parts on bottom side

(without connectors): 2.0 mmPin pitch of connector: 0.8 mmMounting hole diameter: 2.8 mm

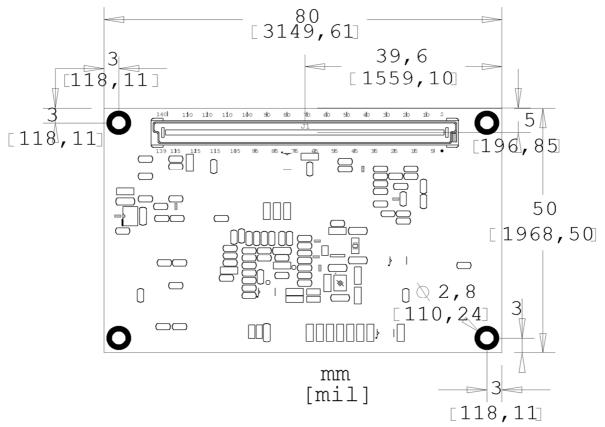


Figure 3: Bottom view - dimension

All values can have tolerances of ±0,5mm.

To avoid EMC and ripple pickup the mounting holes are isolated and not connected to any voltage.



### 5 Technical Data

Power Supply: +3.3V DC /  $\pm 5\%$ 

Current Consumption: max. 1500mA (256MByte Ram)

1900mA (512MByte Ram)

Power supply VBAT 2.0 ... 3.6 V

typical current consumption VBAT: 3 uA

Inputs/Outputs: max. 67 I/O-lines

(shared with dedicated interfaces)

Touch-Screen: 4 wire touch input, resistive

Interfaces: 1x Ethernet 10/100Mbit

3x Serial with 3,3V-level (1x with RTS/CTS) or 4x Se-

rial without RTS/CTS

1x Serial when CAN2.0 not assembled (optional) 1x USB2.0 Device or USB2.0Host (high speed

480Mbit/s)

1x USB2.0 Host (high speed 480Mbit/s)

1x CAN2.0 1x I2C 1x SPI

1x Audio (Line in, Line out, Micro in)

1x microSD slot onboard 1x SD-Card (external)

1x Address/Data-Bus interface

1x HDMI 1x Camera

TFT LCD-interface: up to 1280x720 pixel, 256/65536 colours

Hardware rotation 90 % 180 % 270 °

2D/3D graphic (OpenGL)

Multi format CODEC (MPEG4, H.264, WMV9) Vector Floating Point Coprocessor (VFP)

RAM: 256 MByte DDR2-RAM (optional 512MByte)

Flash: 128 MByte Flash (optional 1GByte)

CPU: Samsung S5PV210 1GHz

Operating Temperature: −25 °C ... +85 °C

Dimensions (I x w x h): 80 x 50 x 4 mm without connector

80 x 50 x 8 mm with connector

Weight: 20 gr.



## 5.1 6.2 DC electrical characteristics for 3.3V IO pins

VDD= 3.3V +/- 5%

Parameter	Description	Condition	Min	Max	Unit
Vih	High Level Input Voltage		0.7*VDD	VDD+0.3	V
Vil	Low Level Input Voltage		-0.3	0.3*VDD	V
Voh	High Level Output Voltage	Ioh=-100μA	VDD-0.2		V
Vol	Low Level Output Voltage	Ioh=100μA		0.2	V
lo	Output current	VDD=3.3V		2.6	mA



## 6 Appendix

## 6.1 Important Notice

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